

Attorney's Docket No. 12732-008001

## COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF, the specification of which:

I hereby claifor patent or inventor han the United State neventor's certificate	Il information I know to be which became available beate of this application:  Serial No.  m foreign priority benefits 's certificate or of any PC's of America listed below or any PCT international a	Filing Date  Filing Date  under Title 35, United States T international application(s) and have also identified belo application(s) designating at let matter having a filing date	defined in Title 37, Code of Federal prior application and the national or PCT  Status  Code, §119 of any foreign application(s) designating at least one country other w any foreign application for patent or least one country other than the United before that of the application(s) of which ate  Priority Claimed
I hereby claison the U.S. S  I hereby claison patent or inventor han the United State inventor's certificate states of America file oriority is claimed:	Il information I know to be which became available beate of this application:  Serial No.  m foreign priority benefits 's certificate or of any PC's of America listed below or any PCT international and by me on the same subject.	Filing Date  Filing Date  under Title 35, United States T international application(s) and have also identified belo application(s) designating at let matter having a filing date	defined in Title 37, Code of Federal prior application and the national or PCT  Status  Code, §119 of any foreign application(s) designating at least one country other w any foreign application for patent or least one country other than the United before that of the application(s) of which
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he duty to disclose a Regulations, §1.56(a)	ll information I know to be ) which became available b	e material to patentability as etween the filing date of the p	defined in Title 37, Code of Federal
elow and, insofar as	s the subject matter of each the manner provided by the	of the claims of this applica first paragraph of Title 35, U	of any United States application(s) listed tion is not disclosed in the prior United Juited States Code, §112, I acknowledge
U.S. S	Serial No.	Filing Date	Status
I hereby cla application(s) listed	im the benefit under Title 3 below:	35, United States Code, §119	e(e)(1) of any United States provisional
I acknowled Fitle 37, Code of Fed	lge the duty to disclose all leral Regulations, §1.56.	information I know to be ma	terial to patentability in accordance with
I hereby stancluding the claims,	te that I have reviewed and , as amended by any amend	understand the contents of t lment referred to above.	he above-identified specification,
on		and as amended under PC	T Article 19 on
	escribed and claimed in PC	T International Application:	9/769,765 and was amended on No filed
[ ] was de	led on <u>January 26, 2001</u> a	s Application Serial No. 09	

business in the Patent and Trademark Office connected therewith:

John F. Hayden, Reg. No. 37,640; Scott C. Harris, Reg. No. 32,030; Michael McKeon, Reg. No. 37,888; Linda Liu Kordziel, Reg. No. 39,732; William E. Booth, Reg. No. 28,933; Ruffin B. Cordell, Reg. No. 33,487; John W. Freeman, Reg. No. 29,066; Timothy A. French, Reg. No. 30,175; G. Roger Lee, Reg. No. 28,963; Ralph A.

## **Combined Declaration and Power of Attorney**

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Mittelberger, Reg. No. 33,195; John B. Pegram, Reg. No. 25,198; Rene D. Tegtmeyer, Reg. No. 33,567; Charles C. Winchester, Reg. No. 21,040; William D. Hare, Reg. No. 44,739; James E. Mrose, Reg. No. 33,264; Lauren A. Degnan, Reg. No. 40,584; Andrew F. Bodendorf, Reg. No. 39,537; Robert V. Racunas, Jr., Reg. No. 43,027; Diana DiBerardino, Reg. No. 45,653; W. Karl Renner, Reg. No. 41,265; Joseph F. Key, Reg. No. 44,827; Harold H. Fox, Reg. No. 41,498; Scott R. Boalick, Reg. No. 42,337; Joseph V. Colaianni, Jr., Reg. No. 39,948; Gregory A. Walters, Reg. No. 41,366; R. Whitney Winston, Reg. No. 44,432; Bing Ai, Reg. No. 43,312; N. Thane Bauz, Reg. No. 41,604; Robert Bedgood, Ph.D., Reg. No.43,488; Gregory P. Einhorn, Reg. No. 38,440; Diane L. Gardner, Reg. No. 36,518; James T. Hagler, Reg. No. 40,631; Kenyon S. Jenckes, Reg. No. 41,873; Samuel S. Lee, Reg. No. 42,791; Christopher S. Marchese, Reg. No. 37,177; Todd G. Miller, Reg. No. 42,003; Shekhar Vyas, Reg. No. 46,166; and John R. Wetherell, Jr., Ph.D., Reg. No. 31,678.

Address all telephone calls to John F. Hayden at telephone number (202) 783-5070.

Address all correspondence to John F. Hayden at:

FISH & RICHARDSON P.C. 601 Thirteenth St., N.W. Washington, DC 20005

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Date: 06/15/2001

Date: 06/11 /200 /

Full Name of Inventor:

Shunpei YAMAZAKI

Inventor's Signature:

Residence Address:

Citizenship:

Post Office Address:

Tokyo, Japan

Japanese

C/O Semiconductor Energy Laboratory Co., Ltd.

398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan

Full Name of Inventor:

tor: Jun KOYAMA

Inventor's Signature:

Residence Address:

Citizenship:

Post Office Address:

Kanagawa, Japan

Japanese

C/O Semiconductor Energy Laboratory Co., Ltd.

398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan

oyama